PG-TSSOP-48-2

Overview

General Information

Package Material	PG
Package Family	TSSOP
Leads/Balls	48
Dash Version	2

Outline

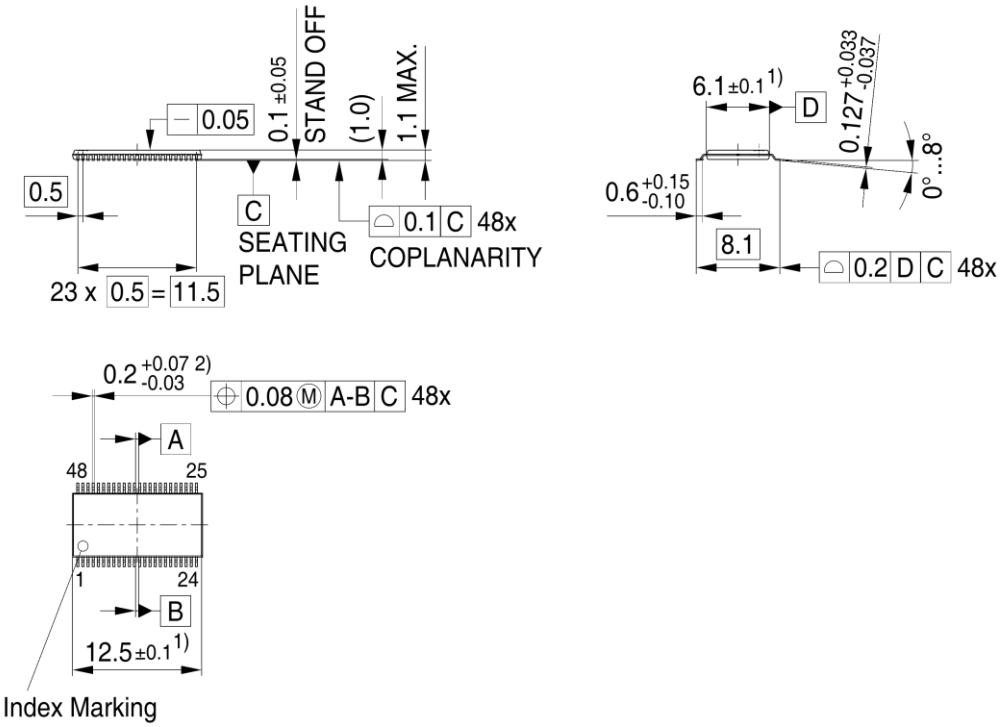
Dimensions

Body Length (mm)	12.50
Body Width (mm)	6.10
Lead/Ball Pitch (mm)	0.50

Exposed Pad

Heatslug	NONE
Exposed Paddle	NONE

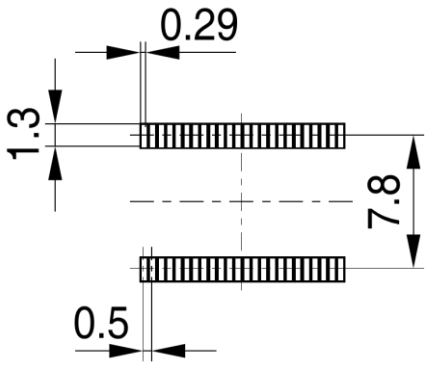
Outline



1) Measured at the bottom parting line; Does not include mold flash or metal protrusions;
Flash or protrusions shall not exceed 0.15 mm per side for dimension 12.5 and 0.25 for dimension 6.1
2) Does not include dambar protrusion of 0.08 max. in excess of leadwidth at the max. material condition;
Min. space between protrusion and an adjacent lead to be 0.08 mm.

PG-TSSOP-48-2-PO V02

Footprint Dimensions

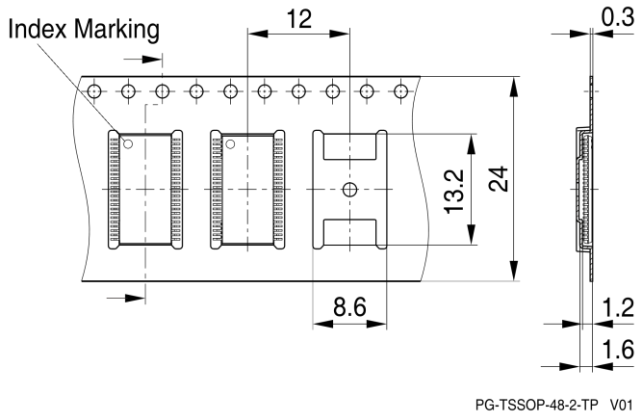


PG-TSSOP-48-2-FP V03

Packing

Tape & Reel

Pieces / Reel	2.000
Reels / Box	
Reel Diameter (mm)	330



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Document reference

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